



N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

DMN3010LFG

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	Ι <sub>D</sub> T <sub>A</sub> = +25°C
30V	8.5mΩ @ V <sub>GS</sub> = 10V	30A
500	10.5mΩ @ V <sub>GS</sub> = 4.5V	25A

#### Description

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

#### Applications

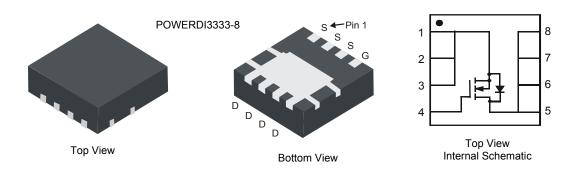
- Backlighting
- DC-DC Converters
- Power Management Functions

#### Features

- Low R<sub>DS(ON)</sub> ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% UIS (Avalanche) rated
- 100% Rg tested
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (approximate)



### Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMN3010LFG-7	Standard	POWERDI3333-8	2000/Tape & Reel
DMN3010LFG-13	Standard	POWERDI3333-8	3000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

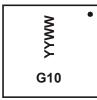
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**

Notes:



G10 = Product marking code YYWW = Date code marking YY = Last digit of year (ex: 10 for 2010) WW = Week code (01 – 53)



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteris	Symbol	Value 30	Unit V		
Drain-Source Voltage	V <sub>DSS</sub>				
Gate-Source Voltage	V <sub>GSS</sub>	±20	V		
	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	11 8.5	А
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	t<10s	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	ID	14 11	А
Continuous Drain Current (Note 5) $V_{GS}$ = 10V	Steady State	T <sub>C</sub> = +25°C T <sub>C</sub> = +100°C	ID	30 20	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%	I <sub>DM</sub>	90	A		
Avalanche Current (Notes 6) L = 0.1mH	I <sub>AR</sub>	24	A		
Repetitive Avalanche Energy (Notes 6) L = 0.1mH	E <sub>AR</sub>	29	mJ		

# **Thermal Characteristics**

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 4)		PD	0.9	W
Thermal Desistance Junction to Ambient (Note 4)	Steady State	D	140	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	t < 10s	R <sub>θJA</sub>	90	°C/W
Total Power Dissipation (Note 5)		PD	2.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	52	°C/W
memorial Resistance, Junction to Ampleht (Note 5)	t < 10s	R <sub>θJA</sub>	35	°C/W
Thermal Resistance, Junction to Case		R <sub>θJC</sub>	4.8	°C/W
Operating and Storage Temperature Range		T <sub>J.</sub> T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

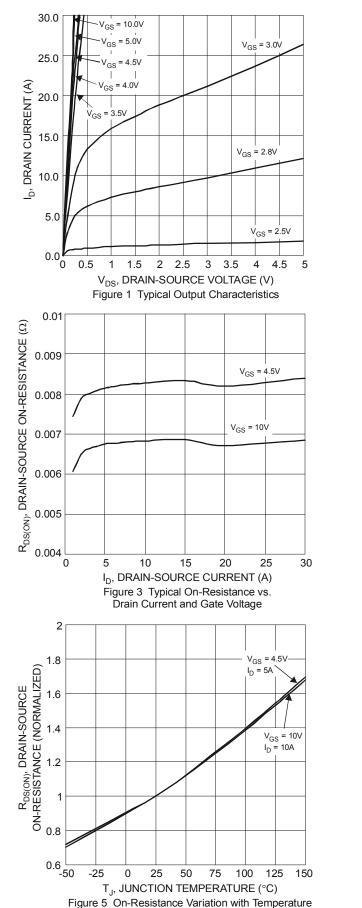
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)						1	
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	6.5	8.5		V <sub>GS</sub> = 10V, I <sub>D</sub> = 18A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	8	10.5	mΩ	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 16A	
Forward Transfer Admittance	Y <sub>fs</sub>	_	20	_	S	V <sub>DS</sub> = 5V, I <sub>D</sub> = 18A	
Diode Forward Voltage	V <sub>SD</sub>		0.75	1.0	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	2075	_		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	190	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	138	_			
Gate resistance	Rg	_	2.4	_	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	16.1	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	37	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	6.1	_	nc	V <sub>DS</sub> = 15V, I <sub>D</sub> = 18A	
Gate-Drain Charge	Q <sub>gd</sub>	_	5.9	_			
Turn-On Delay Time	t <sub>D(on)</sub>		4.5				
Turn-On Rise Time	tr	_	19.6	_		V <sub>DS</sub> = 15V, V <sub>GS</sub> = 10V,	
Turn-Off Delay Time	t <sub>D(off)</sub>		31		ns	R <sub>L</sub> = 0.83Ω, R <sub>GEN</sub> = 3Ω,	
Turn-Off Fall Time	tf		10.7		]		
Reverse Recovery Time	t <sub>rr</sub>		13.7		ns		
Reverse Recovery Charge	Q <sub>rr</sub>	_	18.3	_	nC	- I <sub>F</sub> =15Α, di/dt=500Α/μs	

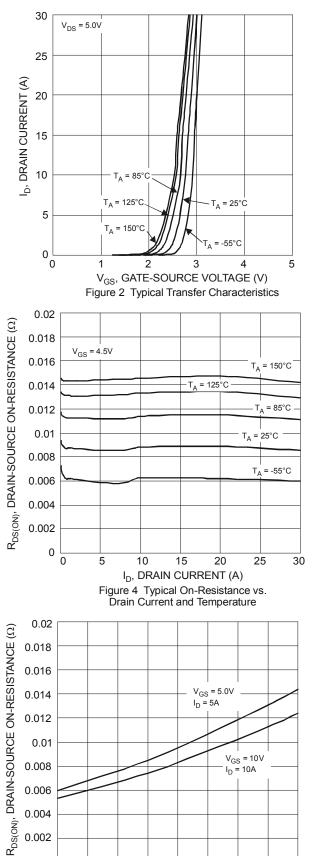
4. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided. Notes:

4. Device mounted on PT-4 PCB with minimum recommended pad layout, single sided. 5. Device mounted on 2" x 2" FR-4 PCB with high coverage 2 oz. Copper, single sided. 6. Repetitive rating, pulse width limited by junction temperature. 7. I<sub>AR</sub> and E<sub>AR</sub> rating are based on low frequency and duty cycles to keep T<sub>J</sub> = +25°C. 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.

### DMN3010LFG







0.008

0.006

0.004

0.002

0

-50

-25

0

25

50

T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

Figure 6 On-Resistance Variation with Temperature

150

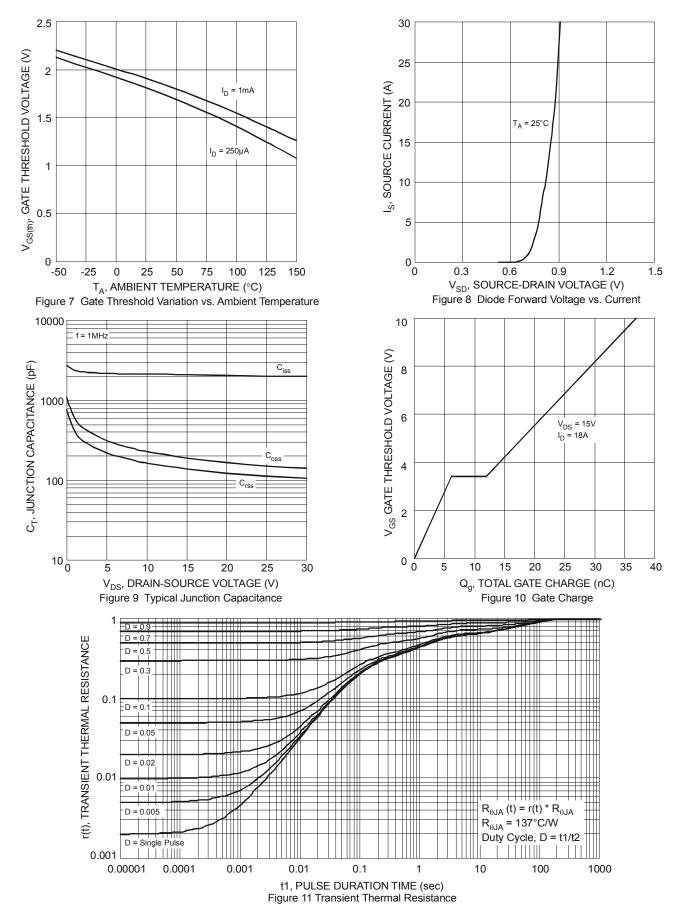
= 10A Ι<sub>D</sub>

100

75

125



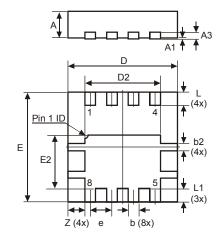


NEW PRODUCT



### **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

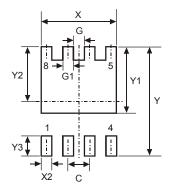


POWERDI <sup>®</sup> 3333-8					
Dim	Min	Max	Тур		
D	3.25	3.35	3.30		
ш	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E2	1.56	1.66	1.61		
Α	0.75	0.85	0.80		
A1	0	0.05	0.02		
A3	-	-	0.203		
b	0.27	0.37	0.32		
b2	-	-	0.20		
L	0.35	0.45	0.40		
L1	-	-	0.39		
е	_	_	0.65		
Ζ	-	-	0.515		
All Dimensions in mm					

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# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	0.230			
G1	0.420			
Y	3.700			
Y1	2.250			
Y2	1.850			
Y3	0.700			
Х	2.370			
X2	0.420			



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